TCXO HIGH STABILITY 105 °C HIGH TEMPERATURE





Product Number

TG5032CKN: X1G006021xxxx14 TG5032SKN: X1G006031xxxx14 TG5032CMN: X1G006041xxxx14 TG5032SMN: X1G006051xxxx14

TG5032CKN/TG5032SKN TG5032CMN/TG5032SMN

Frequency range
Supply voltage
To MHz to 54 MHz
Supply voltage
3.3 V Typ.
Frequency / temperature characteristics

: $\pm 0.1 \times 10^{-6}$ Max. (-40 °C to +105 °C)

•Holdover stability : $\pm 4.6 \times 10^{-6}$ Max. / 20 years (for Stratum3) •External dimensions : $5.0 \times 3.2 \times 1.45$ mm (10 pins or 4 pins) •Applications : Network synchronization, Stratum3, BTS,

SyncE, IEEE1588, Microwave
•Features : 105 °C High temp, High stability







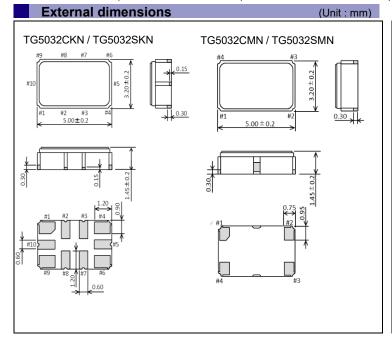
TG5032CMN TG5032SMN (4 pins)

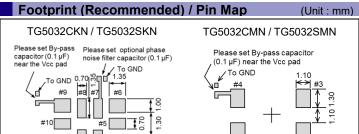
Specifications (characteristics)

Item	Symbol	CMOS	Clipped sine wave	Condition
Output frequency range	fo	10 MHz to 54 MHz		Please contact us about available frequencies.
Supply voltage	V_{CC}	3.3 V ± 5 %		·
Storage temperature	T stg	-40 °C to +105 °C		Storage as single product.
Operating temperature	T_use	-40 °C to +105 °C		
a) Frequency tolerance	f_tol	±1.0 × 10 ⁻⁶ Max.		After reflow, +25 °C
b) Frequency/temperature characteristics	fo-Tc	±0.1 × 10 ⁻⁶ Max.		-40 °C to +105 °C
c) Frequency/load coefficient	fo-Load	±0.1 × 10 ⁻⁶ Max.		Load ± 10 %
(d) Frequency/voltage coefficient	fo-V _{CC}	±0.1 × 10 ⁻⁶ Max.		V _{CC} ± 5 %
e) Frequency aging	£	±0.5 × 10 ⁻⁶ Max.		+25 °C, First year
	f_age	±3.0 × 10 ⁻⁶ Max.		+25 °C, 20 years
Wander generation (MTIE, TD	EV)	Compliant with GR-	1244CORE, ITU-T G.8262	2.1, G.8273.2
Holdover stability (Free-run accuracy)	f_hos	±4.6 × 10 ⁻⁶ Max. / 20 years		This includes Item a), b), c), d) and e)
Current consumption	Icc	7.0 mA Max.	6.0 mA Max.	10 MHz ≤ fo ≤ 26 MHz
		9.0 mA Max.		26 MHz < fo ≤ 40 MHz
		10.0 mA Max.		40 MHz < fo ≤ 54 MHz
Symmetry	SYM	45 % to 55 %	-	GND level (DC cut)
Output voltage	V_{OH}	90 % V _{CC} Min.	-	
	V_{OL}	10 % V _{CC} Max.	-	
	Vpp	-	0.8 V Min.	Peak to Peak
Rise time / Fall time	tr/tf	8.0 ns Max.	-	10 % V _{CC} to 90 % V _{CC} level, Load: 15 pF
Start-up time	t_str	5 ms. Max.		t = 0 at 90 % V _{CC}
Output load condition	Load	15 pF	10 kΩ // 10 pF	
Input voltage	V _{IH}	70% V _{CC} Min.		OE terminal (Enable voltage)
	V_{IL}	30% V _{CC} Max.		OE terminal (Disable voltage)

^{*} Note: Please contact us for requirements not listed in this specification.

- ①Model ②Output (C: CMOS, S: Clipped sine wave) ③Package type (K: 10 pins, M: 4 pins) ④Frequency ⑤Supply voltage (C: 3.3 V Typ.)
- ®Frequency / temperature characteristics (A: ±0.1 × 10⁻⁶ Max.) ⑦Operating temperature (H: -40 °C to +105 °C)
- ®OE function (H: Active High (TG5032CKN/TG5032SKN), N: Non (TG5032CMN/TG5032SMN))





To maintain stable operation, provide a 0.1 µF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{CC} - GND).

Pin	Connection	
1, 2, 5, 8, 10	N.C.	
3	OE	
4	GND	
6	OUT	
7	N.C. or Filter	
9	Vcc	

Pin	Connection	
1	N.C.	
2	GND	
3	OUT	
4	V_{CC}	

OE pin = "H" or "open" : Specified frequency output.
OE pin = "L" : Output is high impedance.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

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